

# 产品规格承认书

## SPECIFICATIONS

客户:

CUSTOMER: \_\_\_\_\_

产品名称:

DESCRIPTION: \_\_\_\_\_ Bipolar antenna

客户型号:

CUSTOMER PART No: \_\_\_\_\_

产品型号:

OUR MODEL NO: \_\_\_\_\_ PBX3216HC01

日期:

DATE: \_\_\_\_\_

确认签字, 盖章后请返回承认书一份

PLEASE RETURN TO US ONE COPY OF "SPECIFICATION FOR APPROVAL"

WITH YOUR APPROVED SIGNATURES

Approved	LiuFei	Audit	LiuFei	Making	LiuXiaoMei
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Customer Acknowledges Signature	
Date	

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DESIGNED BY: Sera					
TITLE: CHIP2450-3216 Specification		DOCUMENT NO.	3216	SPEC REV.	
				P1	

**PBX3216HC01 Specification**

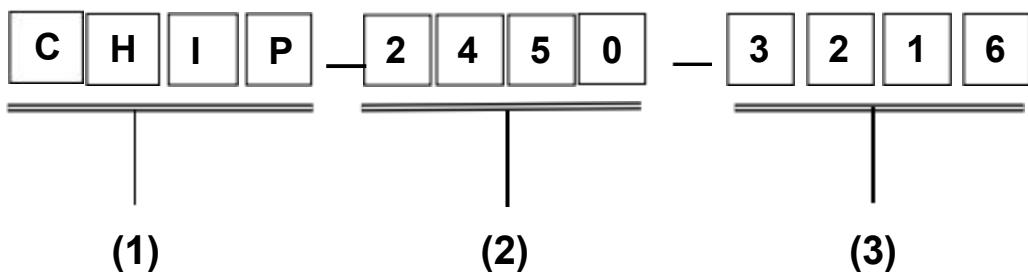
Operating Temp. : -40°C~+85°C

**1. FEATURES:**

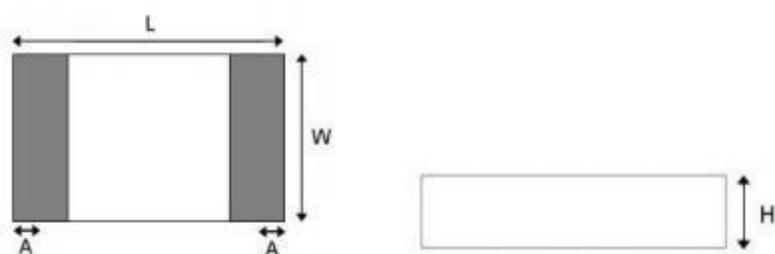
- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain

**2. APPLICATIONS:**

- Bluetooth, Wireless LAN, Mobile TV
- Home RF System, etc

**3. PRODUCT IDENTIFICATION**

- (1) Product type: Multilayer chip Antenna
- (2) Center Frequency: 2450MHz
- (3) External Dimensions (L×W) (mm): 3.2\*1.6

**4. SHAPE AND DIMENSIONS:**

L	W	H	A
3.2±0.2	1.6±0.2	0.52±0.1	0.4±0.1

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ANGLES = ±		HOLE DIA = ±

SCALE: N/A

DRAWN BY : Sera

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UNIT: mm

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APPROVED BY: XD



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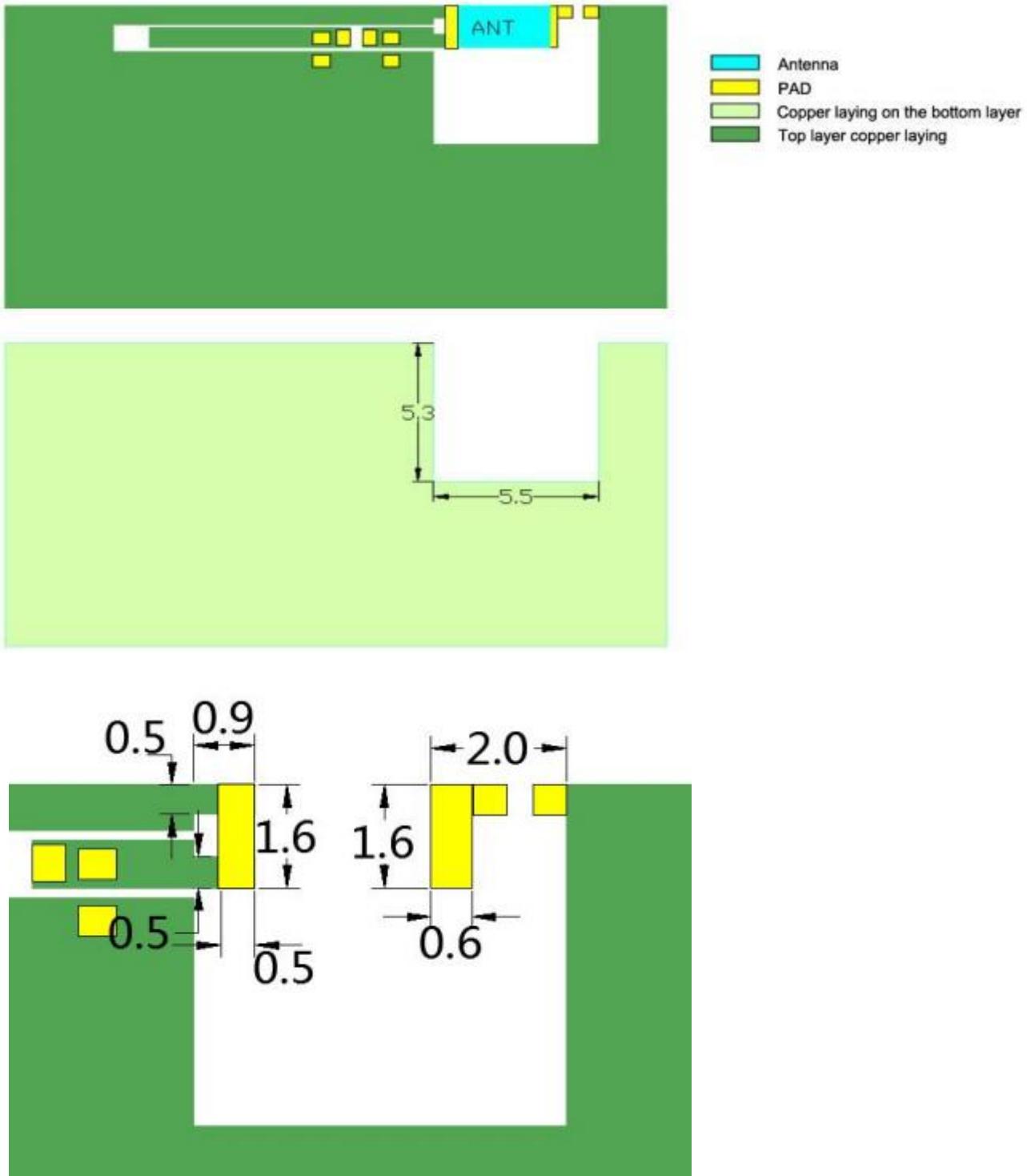
3216

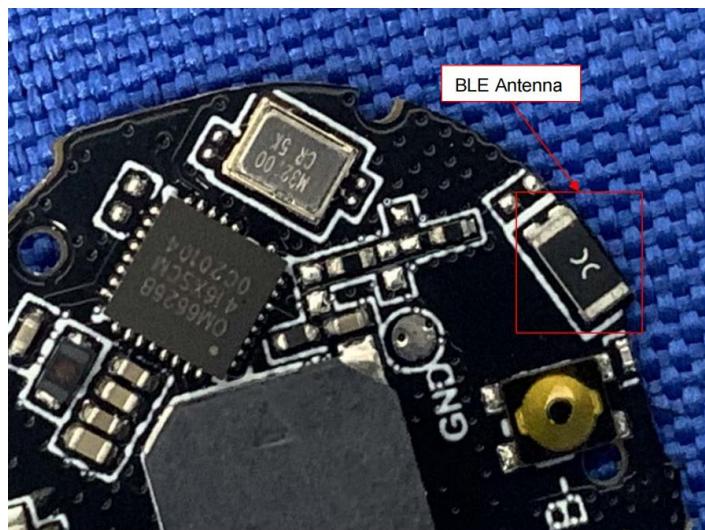
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**Test plate reference size:**

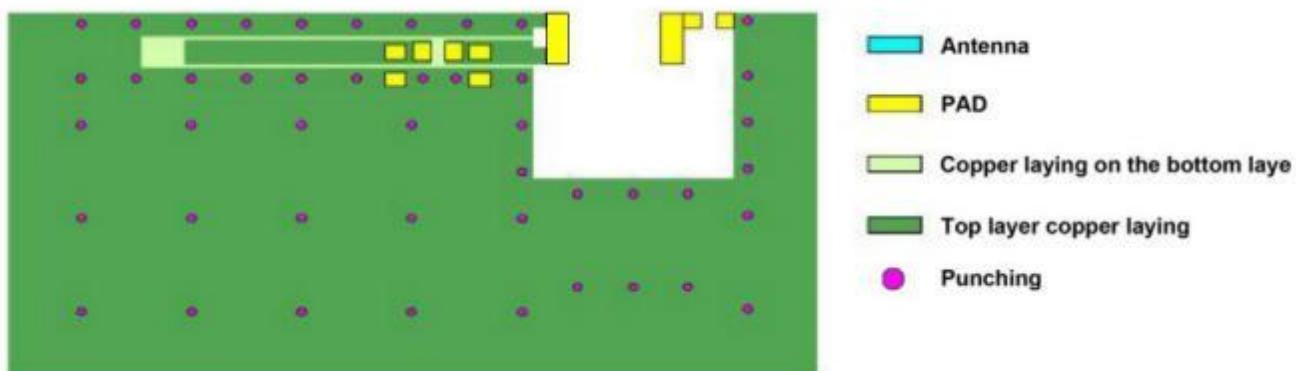
Company: mm



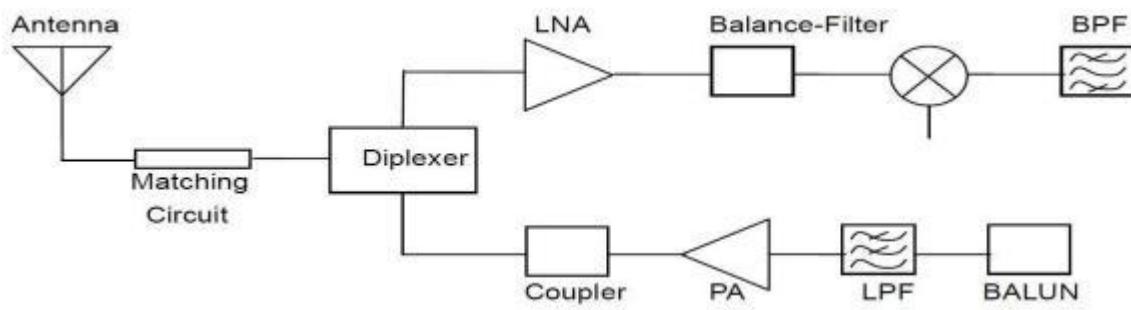


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## Hole punching reference diagram



## APPLICATION GUIDE



## 5. SPECIFICATIONS:

Test Item	Specifications
Bandwidth	2400-2483MHz
Polarization mode	Linear polarization
* Maximum gain	2.67dBi
* Efficiency	72.3%
Input Impedance	50Ω

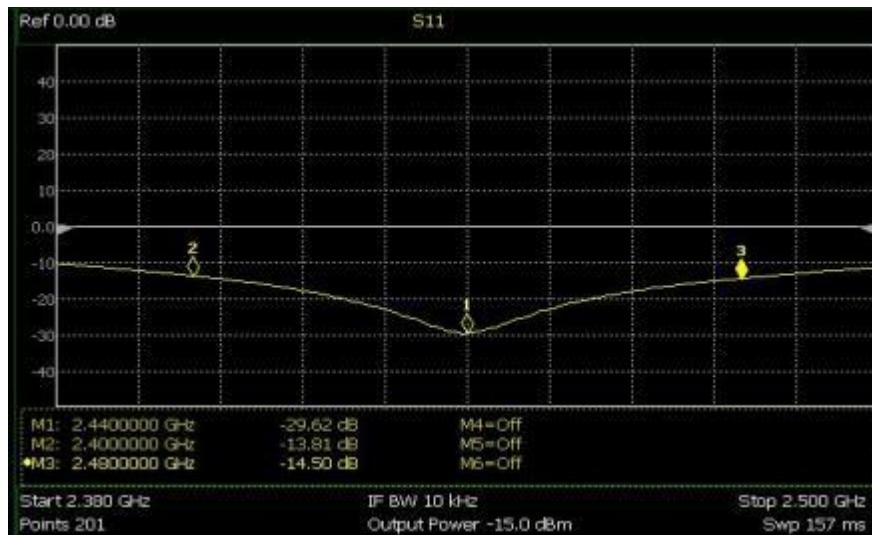
\* Test condition: Test board size 90\*40 mm

Matching circuit: Pi matching circuit will be required

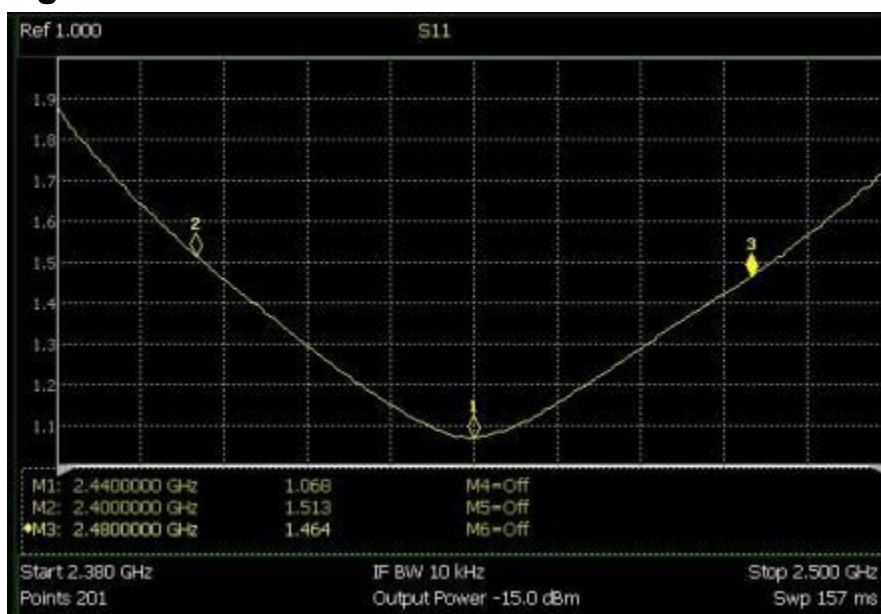
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## 6. Electrical Characteristics :

### Return loss



### Standing wave ratio



Mark	Frequency	VSWR
1	2400 MHz	1. 513
2	2440 MHz	1. 068
3	2480 MHz	1. 464

UNLESS OTHER SPECIFIED TOLERANCES ON:

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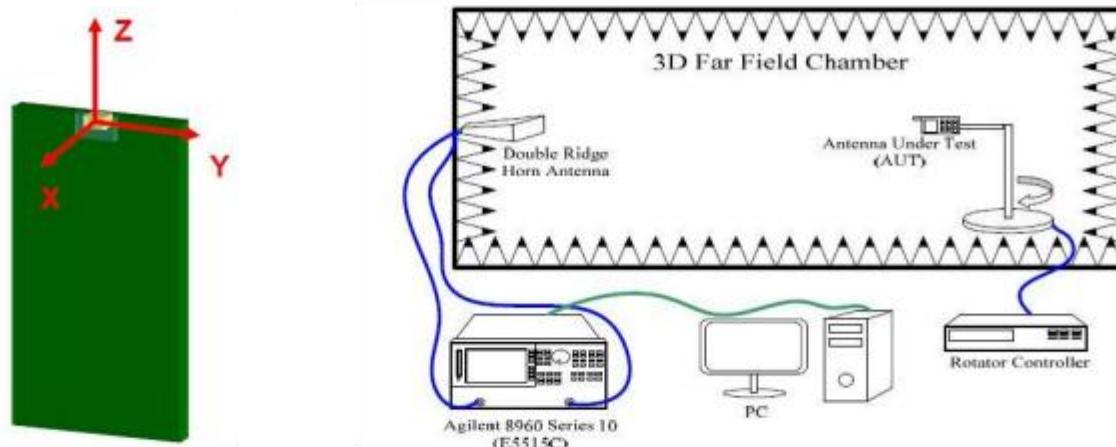
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## Radiation Pattern

The Gain pattern is measured in FAR-field chamber. DUT is placed on the table of rotator, a standard horn antenna and Vector Network Analyzer is used to collect data.



## Efficiency



## Maximum gain



UNLESS OTHER SPECIFIED TOLERANCES ON:		
<b>X = <math>\pm</math></b>	<b>X.X = <math>\pm</math></b>	<b>X.XX = <math>\pm</math></b>
<b>ANGLES = <math>\pm</math></b>		<b>HOLE DIA = <math>\pm</math></b>
<b>SCALE: N/A</b>	<b>UNIT: mm</b>	
<b>DRAWN BY : Sera</b>	<b>CHECKED BY: XD</b>	
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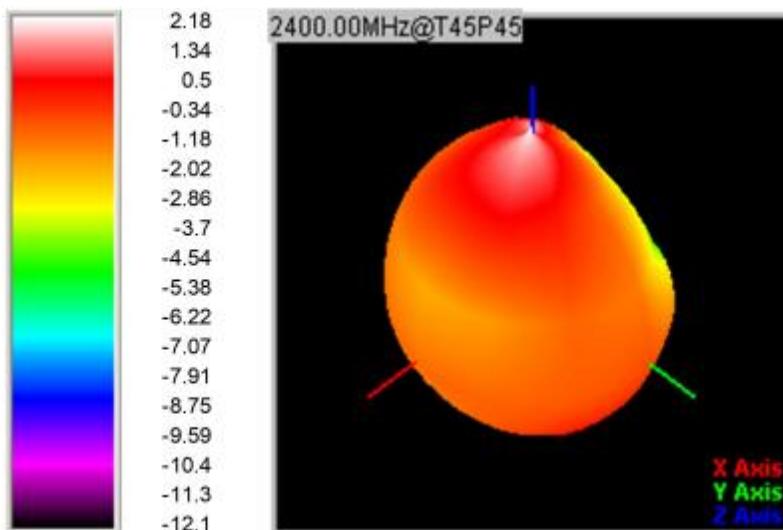


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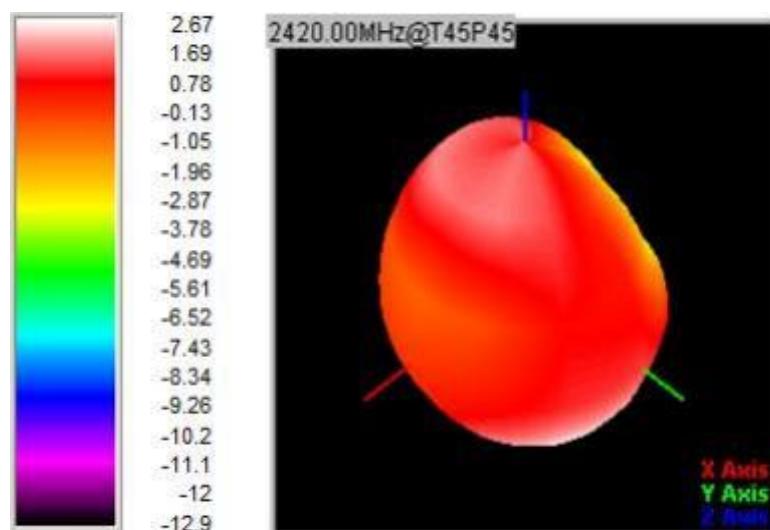
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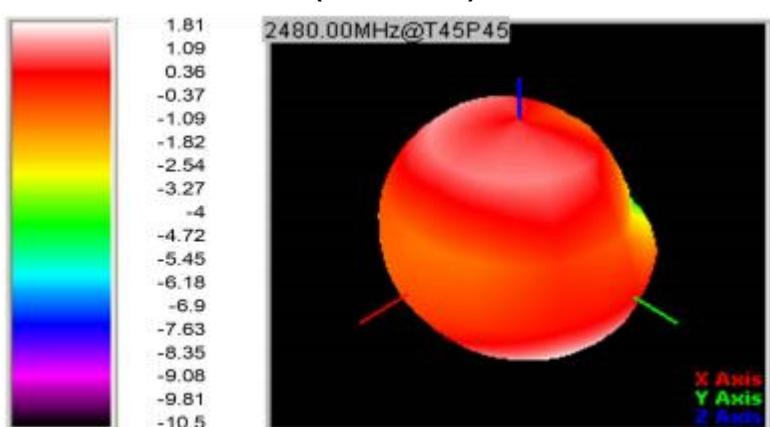
## ◎ 3D Gain Pattern (2400 MHz)



## ◎ 3D Gain Pattern (2420 MHz)



## ◎ 3D Gain Pattern (2480 MHz)



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$X = \pm$	$X.X = \pm$	$X.XX =$
<b>ANGLES</b> = $\pm$		<b>HOLE DIA</b> = $\pm$

SCALE: N/A

UNIT: mm

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## 7. Environmental Characteristics

### (1) Reliability Test

Item	Condition	Specification
Thermal shock	1. $30 \pm 3$ minutes at $-40^\circ C \pm 5^\circ C$ , 2. Convert to $+105^\circ C$ (5 minutes) 3. $30 \pm 3$ minutes at $+105^\circ C \pm 5^\circ C$ , 4. Convert to $-40^\circ C$ (5 minutes) 5. Total 100 continuous cycles	No apparent damage Fulfill the electrical spec. after test.
Humidity resistance	1. Humidity: 85% R.H. 2. Temperature: $85 \pm 5^\circ C$ 3. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
High temperature resistance	1. Temperature: $150^\circ C \pm 5^\circ C$ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Low temperature resistance	1. Temperature: $-40^\circ C \pm 5^\circ C$ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Soldering heat resistance	1. Solder bath temperature : $260 \pm 5^\circ C$ 2. Bathing time: $10 \pm 1$ seconds	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of $245 \pm 5^\circ C$ for $3 \pm 1$ seconds.	No apparent damage

### (2) Storage Condition

#### (a) At warehouse:

The temperature should be within  $0 \sim 30^\circ C$  and humidity should be less than 60% RH.

The product should be used within 1 year from the time of delivery.

#### (b) On board:

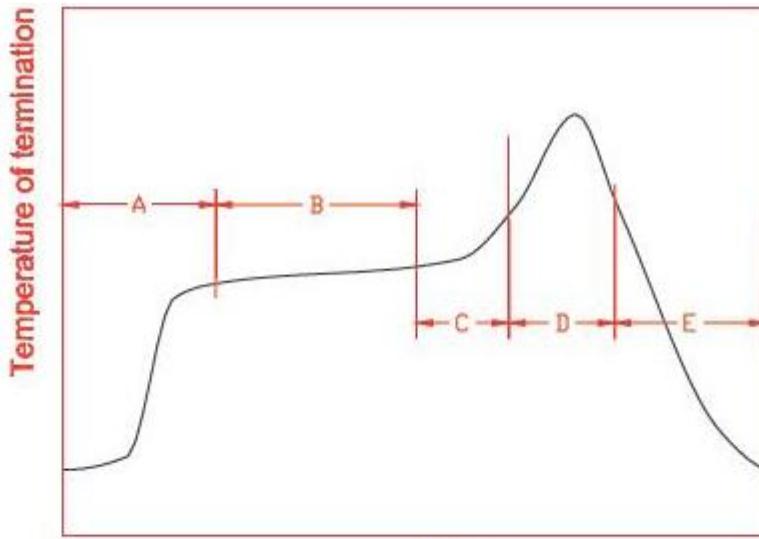
The temperature should be within  $-40 \sim 85^\circ C$  and humidity should be less than 85% RH.

### (3) Operating Temperature Range

Operating temperature range :  $-40^\circ C$  to  $+105^\circ C$ .

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## 8. Recommended Reflow Soldering



		Time	
A	1 <sup>st</sup> rising temperature	The normal to Preheating temperature	30s to 60s
B	Preheating	140°C to 160°C	60s to 120s
C	2 <sup>nd</sup> rising temperature	Preheating to 200°C	20s to 40s
D	Main heating	if 220°C	50s~60s
		if 230°C	40s~50s
		if 240°C	30s~40s
		if 250°C	20s~40s
		if 260°C	20s~40s
E	Regular cooling	200°C to 100°C	1°C/s ~ 4°C/s

\*reference: J-STD-020C

### (1) Soldering Gun Procedure

Note the follows, in case of using solder gun for replacement.

- (a) The tip temperature must be less than 350 ° C for the period within 3 seconds by using soldering gun under 30 W.
- (b) The soldering gun tip shall not touch this product directly.

### (2) Soldering Volume

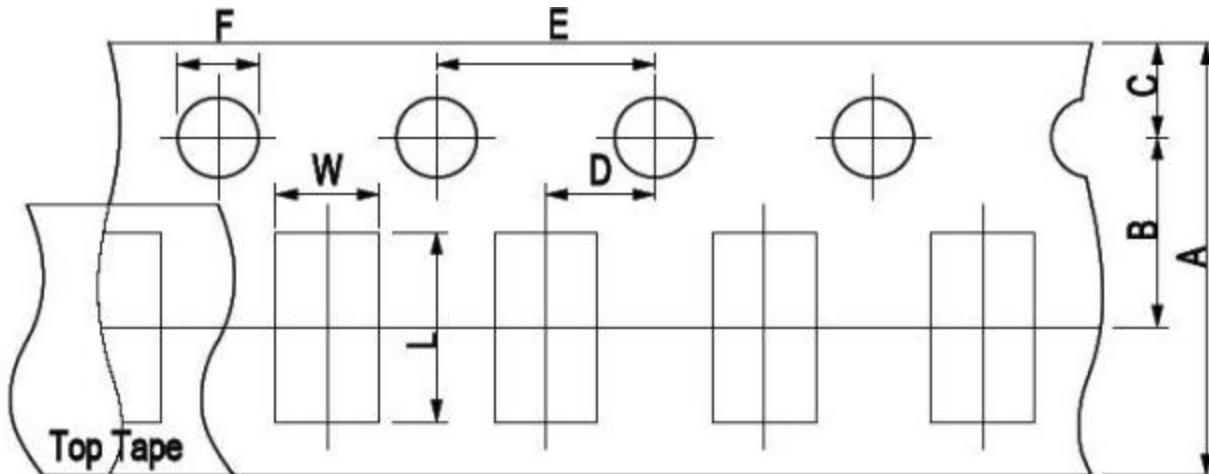
Note that excess of soldering volume will easily get crack the body of this product.

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## 9. Taping Package and Label Marking: (unit: mm)

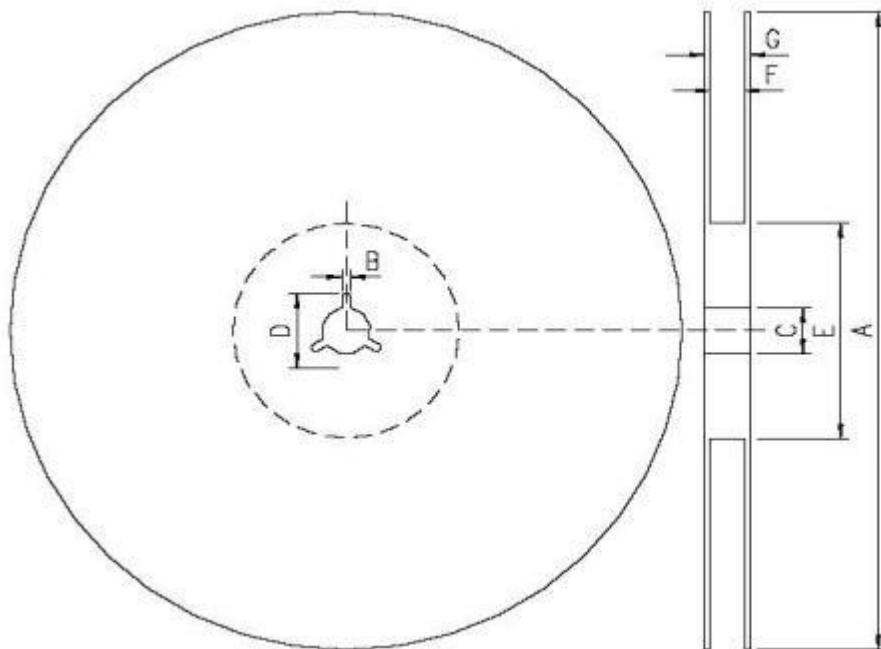
(1) Quantity/Reel: 5000pcs/Reel

(2) Carrier tape dimensions



Type	A	B	C	D	E	F	L	W
2450-21	$8.00 \pm 0.3$	$3.50 \pm 0.05$	$1.75 \pm 0.1$	$2.00 \pm 0.05$	$4.00 \pm 0.1$	$1.50 \pm 0.1$	$2.30 \pm 0.1$	$1.55 \pm 0.1$

(3) Taping reel dimensions



A	$178.0 \pm 2.0$
B	$2.0 \pm 0.5$
C	$13.0 \pm 0.5$
D	$21.0 \pm 0.8$
E	$62.0 \pm 1.5$
F	$9.0 \pm 0.5$
G	$13.0 \pm 1.0$

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**ANGLES** =  $\pm$       **HOLE DIA** =  $\pm$

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